## **DDi Stackup Report**

DDi Tool #:

	Di Otac	Kup III	port	וטט	DDI 1001#.			
Cust: TEXAS INSTRUMENTS - DALLAS			Thickness	s: 0.0620 +/- 0.0060 Ov	er All	Layers: 8		
Part #: <b>720-2152-001</b> Rev: <b>D</b>			Thickness	s: 0.0580 +/- 0.0040		Mat'l: Isola FR370 HR		
Vr# Lam I∥Plated I <sub>□ -</sub> I	Description:	1	Thickness	and Tolerances:				
CondEil I   Plated	Impedance Layers		Copper:	Laminate / PrePreg:	Base Material:			
1 Sig 7	Foil ( T oz )		.00045					
	Preg			.0025 +/- 0.0005	Isola FR370 HR	or equiv		
<del>                                    </del>	Sub Plating		.00040					
2 Sig	Poil (Toz)		.00045					
	Preg			.0028 +/- 0.0005	Isola FR370 HR	or equiv		
Pin	2 Core 0.0060 H/H		.00060	.0060 +/- 0.0006	Isola FR370 HR	or equiv		
Sig	2		.00060					
	Preg			.0045 +/- 0.0005	Isola FR370 HR	or equiv		
	Filler Core 0.0210 0/0				Isola FR370 HR	or equiv		
d	Preg			.0045 +/- 0.0005	Isola FR370 HR	or equiv		
· · · · · · · · · · · · · · · · · · ·	2 Core 0.0060 H/H		.00060 .00060	.0060 +/- 0.0006	Isola FR370 HR	or equiv		
Pln	Preg		.00000	.0028 +/- 0.0005	Isola FR370 HR	or equiv		
Sig	Poil (Toz)		.00045 .00040					
	Preg			.0025 +/- 0.0005	Isola FR370 HR	or equiv		
3 Sig	Poil (Toz)		.00045			<u> </u>		
pedance Requirements:	Original Finish 1:	st Ref. 2n Pln. Re				f Edge to Coplanar Coplana Edge Spacing Spacin		

Imped	dance Requirements:	Original Line	Finish Line	1st Ref. Pln.	2nd Ref.	Z-Ohms (Calc'd)	Z Ohms & Tolerances (+/-%)	Diff Center to Center	Diff Edge to Edge	Coplanar Spacing	Coplanar Spacing
L#	Impedance Type				Pln.		(Required)		(Finished)	(Original)	(Finished)
1	DIF-Coated Microstrip Edg Cpld	.00550	.00550	3	0	101.46	100.0 +/- 10%	.01050	.00500		
1	DIF-Coated Microstrip Edg Cpld	.00650	.00650	3	0	90.47	90.00 +/- 10%	.01050	.00400		
1	SE-Coated Microstrip	.01200	.01200	3	0	49.88	50.00 +/- 10%				
2	DIF-Emb. Microstrip Edg Cpld	.00300	.00300	3	0	100.63	100.0 +/- 10%	.00800	.00500		
2	DIF-Emb. Microstrip Edg Cpld	.00375	.00375	3	0	89.30	90.00 +/- 10%	.00800	.00425		
2	SE-Emb. Microstrip	.00450	.00450	3	0	49.08	50.00 +/- 10%				
3	DIF-Dual Stripline Edg Cpld	.00575	.00575	0	0	99.44	100.0 +/- 10%	.01000	.00425		
4	DIF-Stripline Edg Cpld	.00500	.00500	3	5	99.14	100.0 +/- 10%	.01000	.00500		
4	DIF-Dual Stripline Edg Cpld	.00650	.00650	3	6	89.76	90.00 +/- 10%	.01150	.00500		
4	SE-Dual Stripline	.00900	.00900	3	6	49.81	50.00 +/- 10%				
5	SE-Dual Stripline	.00900	.00900	6	3	49.81	50.00 +/- 10%				
7	SE-Emb. Microstrip	.00450	.00450	6	0	49.08	50.00 +/- 10%				
8	DIF-Coated Microstrip Edg Cpld	.00550	.00550	6	0	101.46	100.0 +/- 10%	.01050	.00500		
8	DIF-Coated Microstrip Edg Cpld	.00650	.00650	6	0	90.47	90.00 +/- 10%	.01050	.00400		
8	SE-Coated Microstrip	.01200	.01200	6	0	49.88	50.00 +/- 10%	· ·			

Controlled Impedance Notes:	Stackup Notes: